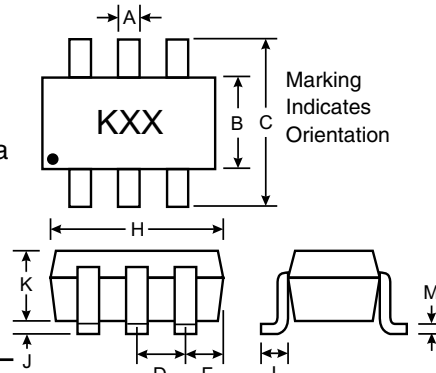


Features

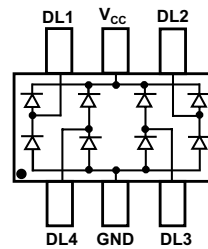
- Low Forward Voltage Drop
- Fast Switching
- Very High Density
- Ultra-Small Surface Mount Package
- PN Junction Guard Ring for Transient and ESD Protection
- Provide transient protection for high-speed data lines in accordance with:
IEC61000-4-2 (ESD) 15kV (Air), 8kV (Contact)
IEC61000-4-4 (EFT) 80A (tp = 5/50 ns)
IEC61000-4-5 (Lightning) Class 3



SOT-363		
Dim	Min	Max
A	0.10	0.30
B	1.15	1.35
C	2.00	2.20
D	0.65 Nominal	
E	0.30	0.40
H	1.80	2.20
J	—	0.10
K	0.90	1.00
L	0.25	0.40
M	0.10	0.25
All Dimensions in mm		

Mechanical Data

- Case: SOT-363, Molded Plastic
- Terminals: Solderable per MIL-STD-202, Method 208
- Polarity: See Diagrams Below
- Weight: 0.006 grams (approx.)
- Marking Code: KST



Maximum Ratings @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	V
Forward Continuous Current	I_{FM}	200	mA
Non-Repetitive Peak Forward Surge Current @ $t < 1.0\text{s}$	I_{FSM}	600	mA
Power Dissipation	P_d	200	mW
Thermal Resistance Junction to Ambient Air	$R_{\theta JA}$	625	$^\circ\text{C/W}$
Operating Temperature Range	T_j	-55 to +125	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-65 to +125	$^\circ\text{C}$

Electrical Characteristics @ $T_A = 25^\circ\text{C}$ unless otherwise specified

Characteristic	Symbol	Typ	Max	Unit	Test Condition
Forward Voltage	V_{FM}	—	280 350 450 550 1000	mV	$I_F = 0.1\text{mA}$, $t_p < 300\mu\text{s}$ $I_F = 1.0\text{mA}$, $t_p < 300\mu\text{s}$ $I_F = 10\text{mA}$, $t_p < 300\mu\text{s}$ $I_F = 30\text{mA}$, $t_p < 300\mu\text{s}$ $I_F = 100\text{mA}$, $t_p < 300\mu\text{s}$
Reverse Current	I_{RM}	—	2	μA	$V_R = 25\text{V}$
Junction Capacitance (Note 1)	C_j	10.0	—	pF	$V_R = 0$, $f = 1.0\text{MHz}$
Reverse Recovery Time	t_{rr}	—	5.0	ns	$I_F = I_R = 10\text{mA}$, $I_{rr} = 0.1 \times I_R$, $R_L = 100\Omega$

Notes: 1. At $V_R = 0\text{V}$, DL(X) to V_{CC} or GND.